



IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:	Shoichi OSADA et al.	Conf.:	9440
Appl. No.:	09/883,276 ✓	Group:	1712
Filed:	June 19, 2001	Examiner:	Marc ZIMMER
For:	SEMICONDUCTOR ENCAPSULATING EPOXY RESIN COMPOSITION AND SEMICONDUCTOR DEVICE		

LARGE ENTITY TRANSMITTAL FORM

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U.S. Patent and Trademark Office  
2011 South Clark Place  
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Crystal Plaza Two, Lobby, Room 1B03  
Arlington, VA 22202

March 19, 2004

Sir:

Transmitted herewith is an amendment in the above-identified application.

- ☐ The enclosed document is being transmitted via the Certificate of Mailing provisions of 37 C.F.R. § 1.8.
- ☐ The enclosed document is being transmitted via facsimile.

The fee has been calculated as shown below:

	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR		PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL	13	-	20	=	0	\$ 18	\$0.00
INDEPENDENT	4	-	4	=	0	\$ 86	\$0.00
<input type="checkbox"/> FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM						\$290	\$0.00
						TOTAL	\$0.00

- ☐ Petition for ( ) month(s) extension of time pursuant to 37 C.F.R. §§ 1.17 and 1.136(a). \$0.00 for the extension of time.
- ☒ No fee is required.
- ☐ Check(s) in the amount of \$0.00 is(are) enclosed.
- ☐ Please charge Deposit Account No. 02-2448 in the amount of \$0.00. This form is submitted in triplicate.


If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. § 1.16 or under 37 C.F.R. § 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By 

Andrew D. Meikle, #32,868

  
ADM/RG/csm  
0171-0759P

P.O. Box 747  
Falls Church, VA 22040-0747  
(703) 205-8000

Attachment(s)

(Rev. 09/30/03)



MS IF  
REPLY UNDER 37 C.F.R. § 1.312  
EXPEDITED PROCEDURE  
EXAMINING GROUP 1712  
PATENT  
0171-0759P

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**AMENDMENT UNDER 37 CFR 1.312**

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**Arlington, VA 22202**

March 19, 2004

Sir:

The following amendments and Remarks are respectfully submitted in connection with the above-identified application.

This Paper includes:

Amended Claim Set; and  
Remarks.